

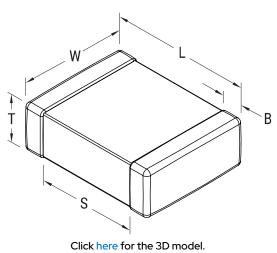
General Information

Specifications

Insulation Resistance



CAN SMD Indust 250, Ceramic, 110 pF, 2%, COG, SMD Chip, MLCC, AC Rated, 0603, 0.5 mm



	Series	CAN SMD Indust 250
	Style	SMD Chip
	Description	SMD Chip, MLCC, AC Rated
	Features	Temperature Stable, Class I
	RoHS	Yes
	Termination	Tin
	Marking	No
	AEC-Q200	No
	Typical Component Weight	4.6 mg
	Shelf Life	78 Weeks
	MSL	1

Dimensions		
Chip Size	0603	
L	1.6mm +/-0.15mm	
W	0.8mm +/-0.15mm	
Т	0.8mm +/-0.10mm	
S	0.5mm MIN	
В	0.35mm +/-0.15mm	

Capacitance	110 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	2%
Voltage AC	250 VAC
Dielectric Withstanding Voltage	945 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour

10 GOhms

Packaging Specifications	
Packaging	T&R, 330mm, Paper Tape
Packaging Quantity	15000

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